

RZ/T2H and RZ/N2H Power Requirements

Design of Power Supply Circuits for RZ/T2H and RZ/N2H using DA9080, DA9220 and DA9217.

This document describes all the default register settings of the DA9080, DA9220, and DA9217, for supplying power to the RZ/T2H or RZ/N2H system and associated peripherals. It focuses primarily on DA9080's configuration with respect to the RZ/T2H and RZ/N2H power on/off requirements.

The DA9080 is a high-performance, low cost, five channel PMIC designed for 32-bit and 64-bit MCU / MPU applications. The internally compensated regulators provide a highly integrated, small footprint power solution for System-On-Module (SOM) applications.

DA9220 integrates two single-phase buck converters. Each has the capability to deliver up to 3 A output current at a 0.3 V to 1.9 V output voltage range.

DA9217 operates as a single-channel, dual-phase buck converter capable of delivering up to 6 A output current at a 0.3 V to 1.9 V output voltage range.

Higher output voltages (up to 3.3 V) can be achieved by DA9217 and DA9220 using an external feedback divider network.

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1. Terms and Definitions

ADC	Analog to digital converter
CH<x>	Channel <x>, where x = 1 to 4
FCQFN	Flip chip quad flat-pack no-lead (package)
LDO	Low drop out (regulator)
OTP	One time programmable
PG	Power good
SOM	System-on-Module
WLCSP	Wafer level chip scale package

2. References

- [1] DA9080_Datasheet, Renesas Electronics.
- [2] DA9217_Datasheet, Renesas Electronics.
- [3] DA9220_Datasheet, Renesas Electronics.
- [4] RZ/T2H and RZ/N2H Group Datasheet, Renesas Electronics.

Note 1 References are for the latest published version, unless otherwise indicated.

3. Power Requirements

The power on/off sequence and timings are illustrated in the figure and table below.

For power-up, initiate with a supply of 0.8 V (VDD08), followed by 1.8 V (VDD18 and AVDD), then 1.1 V, and finally 3.3 V (DDR_VDDQ and VDD33).

Ensure the power-up sequence is completed within 100 ms, maintaining the Reset signal (RES#) in a Low state throughout this process.

For power-down, release 1.1 V and 3.3 V (DDR_VDDQ and VDD33) first, followed by 0.8 V and 1.8 V (VDD08, VDD18, and AVDD). Complete the power-down sequence within 100 ms.

Ensure the rise time for each power supply during power-up exceeds 40 μ s, and the fall time during power-down exceeds 10 μ s.

Apply power supply voltages and reset signals with a monotonic increase. Avoid the application of negative voltage to power supply voltages. Provide a stable clock to the XTAL/XTAL or EXTCLKIN pin when the reset signal (RES#) is driven high.

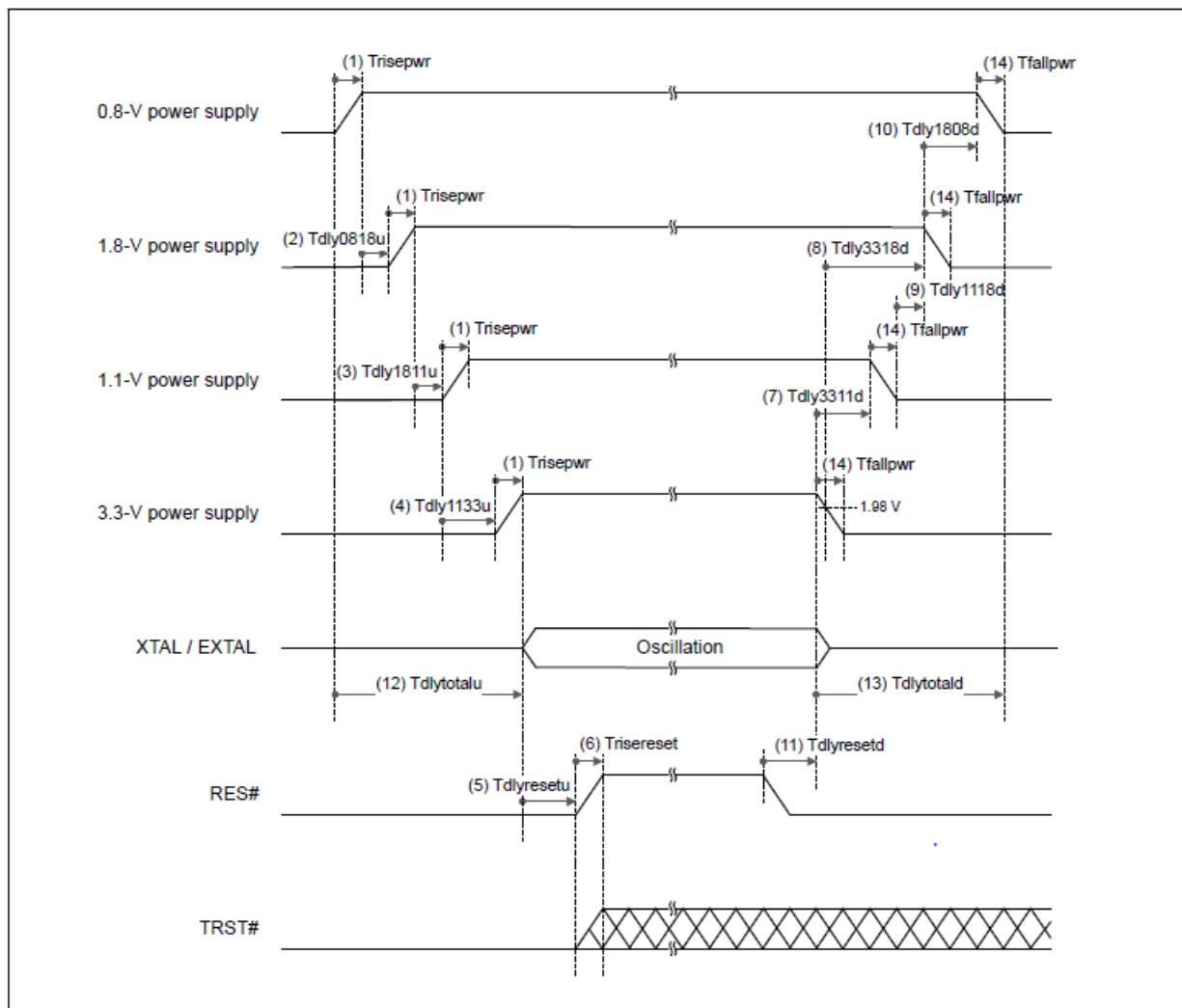


Figure 1. Period for Power Rise for RZ/T2H and RZ/N2H

Table 1. Power on/off Sequence Timing

No	Symbol	Description	Value		
			Min.	Typ.	Max.
(1)	Trisepwr	Rising time of the power supply voltage	40 μ s		30 ms
(2)	Tdly0818u	Delay time from completion of rising of the 0.8 V power supply voltage to start of rising of the 1.8 V power supply voltage	1 μ s		100 ms
(3)	Tdly1811u	Delay time from completion of rising of the 1.8 V power supply voltage to start of rising of the 1.1 V power supply voltage	0		100 ms
(4)	Tdly1133u	Delay time from start of rising of the 1.1 V power supply voltage to start of rising of the 3.3 V power supply voltage	0		100 ms
(5)	Tdlyresetu	Delay time from completion of rising of the 3.3 V power supply voltage to start of rising of RES#	10 ms		
(6)	Trisereset	Rising time of RES#			150 μ s
(7)	Tdly3311d	Delay time from start of falling of the 3.3 V power supply voltage to start of falling of the 1.1 V power supply voltage	0		100 ms
(8)	Tdly3318d	Delay time from the time when 3.3 V power supply voltage drops below 1.98 V to start of falling of the 1.8 V power supply voltage	0		100 ms
(9)	Tdly1118d	Delay time from completion of falling of the 1.1 V power supply voltage to start of falling of the 1.8 V power supply voltage	0		100 ms
(10)	Tdly1808d	Delay time from start of falling of the 1.8 V power supply voltage to start of falling of 0.8 V power supply voltage	0		100 ms
(11)	Tdlyresetd	Delay time from start of falling of RES# to start of falling of the 3.3 V power supply voltage	10 μ s		
(12)	Tdlytotalu	Startup time of all power supply voltage	0		100 ms
(13)	Tdlytotald	Shut down time of all power supply voltage	0		100 ms
(14)	Tfallpwr	Falling time of the power supply voltage	10 μ s		30 ms

4. Power Supply Tree Diagram

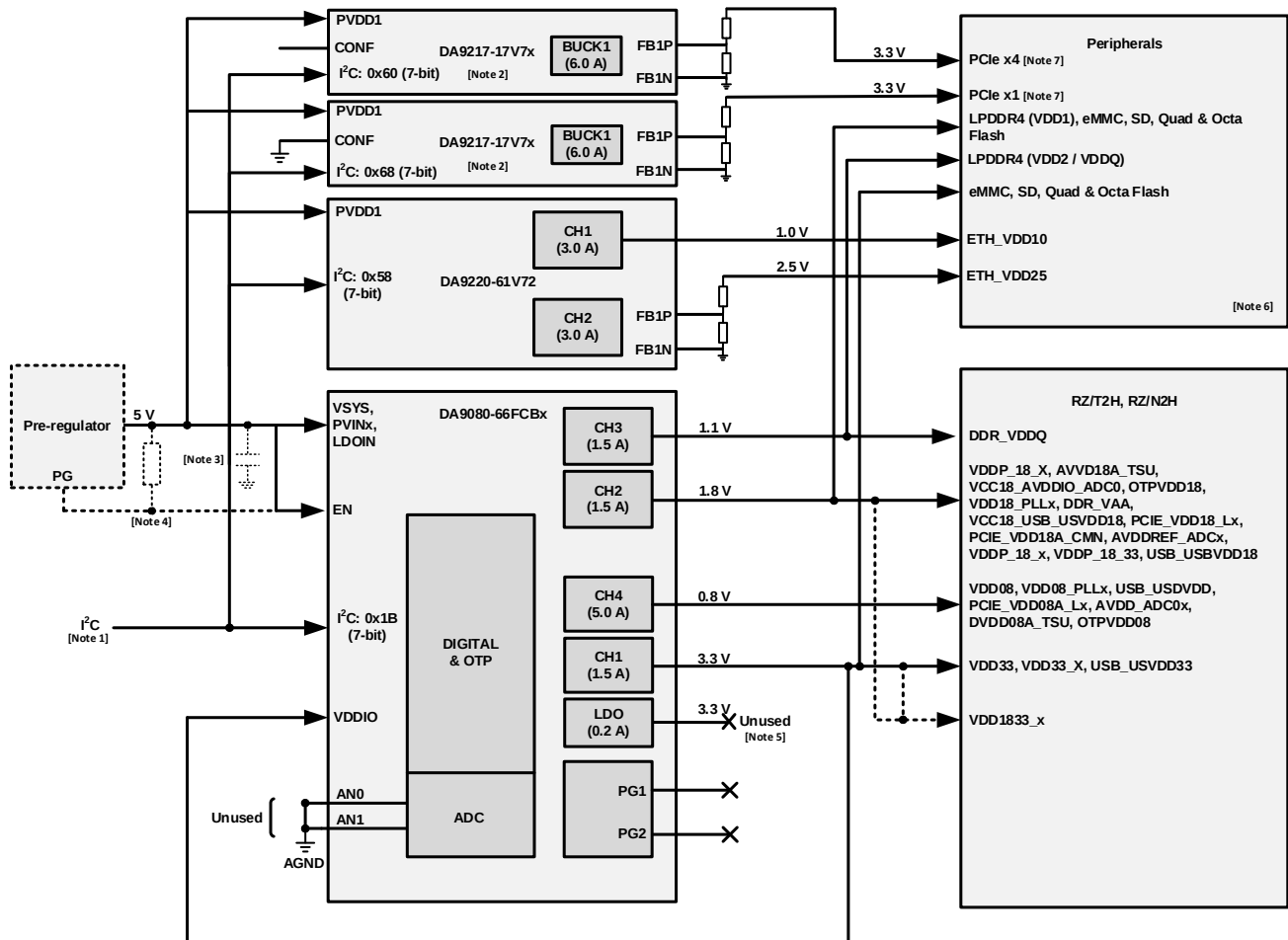


Figure 2. RZ/T2H or RZ/N2H Power Tree with PCI-E

- Note 1** The I²C (SCL and SDA) should be connected to the RZ/T2H or RZ/N2H MPU.
- Note 2** If PCI-E is unused, the two DA9217 devices can be removed from the system.
- Note 3** A large bulk capacitor (100 μF ~ 1000 μF) should be added to the 5V input of DA9080 or to the input of the pre-regulator.
- Note 4** If a pre-regulator is used to supply DA9080, it is recommended to connect the pre-regulator's PG to the DA9080's EN.
- Note 5** The DA9080 LDO is shown as unused, though as it starts up in Slot 4; it could be used to enable the DA92xx devices.
- Note 6** The peripherals included here are for example purposes; others may be able to be powered by the DA92xx/DA9080 devices. Designers should ensure their power demands are appropriate.
- Note 7** PCIe 12V rails can be supplied by an external switching regulator (e.g., [RAA211650](#)).

5. Power On Sequence

Table 2. Power Sequence

	RZ/N2H or RZ/T2H: DA9080 Channel (Output Voltage)
Slot 1	DA9080 CH4 (0.80 V)
Slot 2	DA9080 CH2 (1.80 V)
Slot 3	DA9080 CH3 (1.10 V)
Slot 4	DA9080 CH1 (3.30 V) DA9080 LDO (3.30 V)

Note 1 The power down sequence is the reverse of the power up sequence.

Channel 1: DA9080 CH1 (3.30 V), Channel 2: DA9080 CH2 (1.80 V), Channel 3: DA9080 CH3 (1.10 V),
Channel 4: DA9080 CH4 (0.80 V)

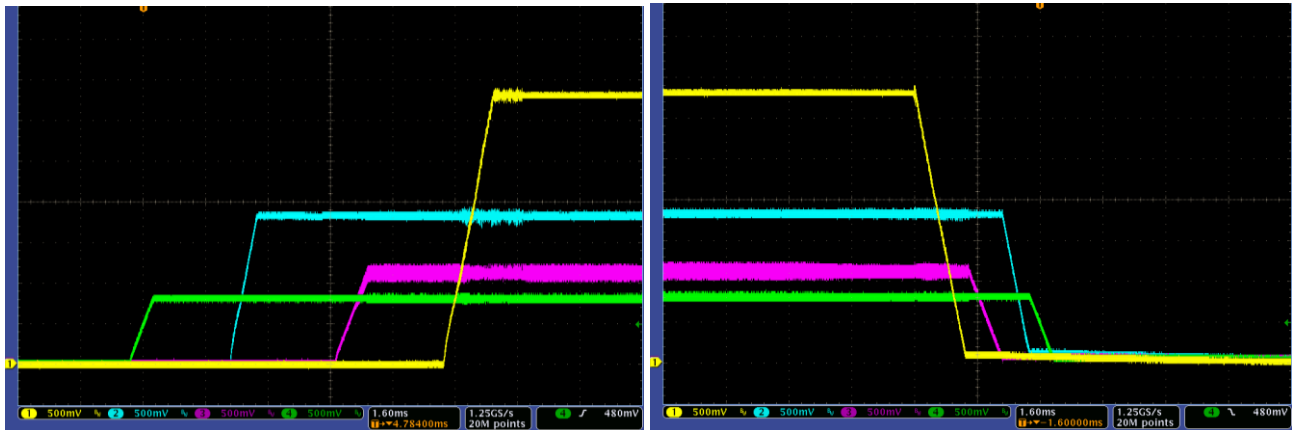


Figure 3. DA9080-66FCBx Power Up/Down

6. Detailed Description

Table 3. Register Settings DA9080-66FCBx (I2C slave address is 0x1B (7-bit))

Register Address	Register Name	Default Value	Description
0x04	PMC_ADC_ENABLE	0x00	ADC disabled
0x05	PMC_CH_EN	0x1F	CH1, CH2, CH3, CH4 and LDO enabled
0x07	PMC_VOUT_BUCK1	0x3C	VCH1 = 3.30 V
0x08	PMC_VOUT_BUCK2	0x0F	VCH2 = 1.80 V
0x09	PMC_VOUT_BUCK3	0x28	VCH3 = 1.10 V
0x0A	PMC_VOUT_BUCK4	0x00	VCH4 = 0.80 V
0x0B	PMC_PHASE_INTERLEAVING	0x88	BUCK1_PHASE = 0° BUCK2_PHASE = 180° BUCK3_PHASE = 0° BUCK4_PHASE = 180°
0x0C	PMC_BUCK_SEQ_GRP	0x27	CH1 = SLOT4, CH2 = SLOT2 CH3 = SLOT3, CH4 = SLOT1
0x0D	PMC_LDO_SEQ_GRP	0x03	LDO = SLOT4
0x0E	PMC_PG1	0x1C	CH2, CH3 and CH4 assigned to PG1

Register Address	Register Name	Default Value	Description
0x0F	PMC_PG2	0x03	CH1 and LDO assigned to PG1
0x10	PMC_DISCHARGE	0x1F	CH<x> and LDO discharge enabled
0x62	OTP_CONFIG_ID	0x66	OTP variant number: DA9080-66FCBx

Table 4. Register Settings DA9220-61V72 (I2C slave address is 0x58 (7-bit))

Register Address	Register Name	Default Value	Description
0x07	SYS_MASK_0	0x07	nIRQ interrupt, all masked
0x08	SYS_MASK_1	0xFF	nIRQ interrupt, all masked
0x09	SYS_MASK_2	0x07	nIRQ interrupt, all masked
0x0A	SYS_MASK_3	0x0F	nIRQ interrupt, all masked
0x0D	SYS_CONFIG_2	0x00	Over current latch-off function is disabled. PG and OC are not masked during DVC. 2CH-1PH + 1PH configuration
0x0E	SYS_CONFIG_3	0x02	Oscillator tuning (OSC_TUNE) is off. I2C_TIMEOUT is enabled
0x10	SYS_GPIO0_0	0x00	GPIO0 is set to CONF pin
0x20	BUCK_BUCK1_0	0x48	CH1 is off by default. DVC ramp-up and ramp-down slew rate is set to 20 mV/μs
0x21	BUCK_BUCK1_1	0x48	VOUT discharge resistor is disabled. Soft start and shut-down slew rate is set to 20 mV/μs
0x22	BUCK_BUCK1_2	0x05	ILIM is set to 5.5 A/phase
0x23	BUCK_BUCK1_3	0xBE	Maximum output voltage is set to 1.9 V
0x24	BUCK_BUCK1_4	0x0F	Buck is set to auto mode (both CH1_A_MODE and CH1_B_MODE). CH1_A_VOUT is selected by default
0x25	BUCK_BUCK1_5	0x64	CH1_A_VOUT = 1.00 V
0x26	BUCK_BUCK1_6	0x64	CH1_B_VOUT = 1.00 V
0x27	BUCK_BUCK1_7	0x03	Large ripple cancel
0x28	BUCK_BUCK2_0	0x48	CH2 is off by default. DVC ramp-up and ramp-down slew rate is set to 20 mV/μs
0x29	BUCK_BUCK2_1	0x48	VOUT discharge resistor is disabled. Soft start and shut-down slew rate is set to 20 mV/μs
0x2A	BUCK_BUCK2_2	0x05	ILIM is set to 5.5 A/phase
0x2B	BUCK_BUCK2_3	0xBE	Maximum output voltage is set to 1.9 V
0x2C	BUCK_BUCK2_4	0x0F	Buck is set to auto mode (both CH2_A_MODE and CH2_B_MODE). CH2_A_VOUT is selected by default
0x2D	BUCK_BUCK2_5	0x64	CH2_A_VOUT = 1.00 V
0x2E	BUCK_BUCK2_6	0x64	CH2_B_VOUT = 1.00 V
0x2F	BUCK_BUCK2_7	0x03	Large ripple cancel

Table 5. Register Settings DA9217-17V72, CONF = Low (I2C slave address is 0x68 (7-bits))

Register Address	Register Name	Default Value	Description
0x07	SYS_MASK_0	0x07	nIRQ interrupt, all masked
0x08	SYS_MASK_1	0xFF	nIRQ interrupt, all masked
0x09	SYS_MASK_2	0x07	nIRQ interrupt, all masked
0x0A	SYS_MASK_3	0x0F	nIRQ interrupt, all masked
0x0D	SYS_CONFIG_2	0x01	Over current latch-off function is disabled. PG is not masked during DVC. 1CH-2PH configuration
0x0E	SYS_CONFIG_3	0x02	Oscillator tuning (OSC_TUNE) is off. I2C_TIMEOUT is enabled
0x10	SYS_GPIO0_0	0x00	GPIO0 is set to CONF pin
0x20	BUCK_BUCK1_0	0x49	CH1 is enabled by default. DVC ramp-up and ramp-down slew rate is set to 20 mV/μs
0x21	BUCK_BUCK1_1	0x46	VOOUT discharge resistor is enabled. Soft start slew rate is set to 10 mV/μs and shut-down slew rate is set to 20 mV/μs
0x22	BUCK_BUCK1_2	0x05	ILIM is set to 5.5 A/phase
0x23	BUCK_BUCK1_3	0xBE	Maximum output voltage is set to 1.9 V
0x24	BUCK_BUCK1_4	0x0F	Buck is set to auto mode (both CH1_A_MODE and CH1_B_MODE). CH1_A_VOUT is selected by default
0x25	BUCK_BUCK1_5	0xA5	CH1_A_VOUT = 1.65 V
0x26	BUCK_BUCK1_6	0xA5	CH1_B_VOUT = 1.65 V

Table 6. Register Settings DA9217-17V72, CONF = Hi-Z (I2C slave address is 0x60 (7-bits))

Register Address	Register Name	Default Value	Description
0x07	SYS_MASK_0	0x07	nIRQ interrupt, all masked
0x08	SYS_MASK_1	0xFF	nIRQ interrupt, all masked
0x09	SYS_MASK_2	0x07	nIRQ interrupt, all masked
0x0A	SYS_MASK_3	0x0F	nIRQ interrupt, all masked
0x0D	SYS_CONFIG_2	0x01	Over current latch-off function is disabled. PG is not masked during DVC. 1CH-2PH configuration
0x0E	SYS_CONFIG_3	0x02	Oscillator tuning (OSC_TUNE) is off. I2C_TIMEOUT is enabled
0x10	SYS_GPIO0_0	0x00	GPIO0 is set to CONF pin
0x20	BUCK_BUCK1_0	0x49	CH1 is enabled by default. DVC ramp-up and ramp-down slew rate is set to 20 mV/μs
0x21	BUCK_BUCK1_1	0x46	VOOUT discharge resistor is enabled. Soft start slew rate is set to 10 mV/μs and shut-down slew rate is set to 20 mV/μs
0x22	BUCK_BUCK1_2	0x05	ILIM is set to 5.5 A/phase
0x23	BUCK_BUCK1_3	0xBE	Maximum output voltage is set to 1.9 V

Register Address	Register Name	Default Value	Description
0x24	BUCK_BUCK1_4	0x0F	Buck is set to auto mode (both CH1_A_MODE and CH1_B_MODE). CH1_A_VOUT is selected by default
0x25	BUCK_BUCK1_5	0xA5	CH1_A_VOUT = 1.65 V
0x26	BUCK_BUCK1_6	0xA5	CH1_B_VOUT = 1.65 V

7. Variant Table and Ordering Information

Table 7. Variant Table

Part Number	Package	Size (mm)	Shipment Form	Pack Quantity
DA9080-66FCB2	32 FCQFN	5.0 x 5.0 by 0.5 mm pitch	Tape & Reel	6000
DA9080-66FCBC				1000
DA9220-61V72	24 WLCSP	2.48 x 1.68 by 0.4 mm pitch	Tape & Reel	4500
DA9217-17V72	24 WSLCP	2.48 x 1.68 by 0.4 mm pitch	Tape & Reel	4500

Revision History

Revision	Date	Description
1.0	Mar 31, 2025	First version.

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